

CELCO 1003

STANDARD PROCEDURE FOR ELECTROPOLISHING AND HANDLING COMPONENTS FOR ULTRA HIGH PURITY APPLICATIONS

Rev. A

Dated: October 29, 2008

Reviewed and approved for adequacy prior to issue by:

 11/04/08

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 11/04/08

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Revision History

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Add approval signatures and dates.

1.0 SCOPE

- 1.1 This document establishes a standard procedure for handling components which are electro polished and packaged for Class 100 standards.
- 1.2 The material is assumed to be a type 316L stainless steel but other austenitic stainless steel shall be handled in the same manner.

2.0 PROCESS MATERIAL

2.1 ELECTROPOLISHING FLUID

- 2.1.1 The electrolyte used for electro polishing components a commercial grade fluid which is closely monitored required by the supplier to assure a consistent polished surface.

2.2 D. I. WATER

- 2.2.1 Resisitivity - 8-10 Meg Ohm
- 2.2.2 Filtration - .2 micron

2.3 NITROGEN

- 2.3.1 SOURCE - BOTTLED
- 2.3.2 PURITY - 99.998%

2.4 CLEAN WIPES - Commercial Lint Free

3.0 RECEIVING AND INSPECTION

- 3.1 Inspect incoming components flaws and determine if manufacture initiated or caused by shipping.
 - 3.1.1 Notify customer of rejected parts.
- 3.2 Initiate work order with description of component, part number, quantity, E.P. requirement, inspection information, and other pertinent information.

- 3.3 Clean component to remove surface contaminants.
- 3.4 If heat scale or discoloration is evident, pickle the component in a nitric acid bath until the scale is dissolved.

4.0 ELECTROPOLISHING

- 4.1 The component is racked and electropolished to obtain the required final finish.
- 4.2 Rinsing Procedure
 - 4.2.1 Drag out in potable water.
 - 4.2.2 Pig rinse in nitric acid solution.
 - 4.2.3 Second rinse in potable water.
 - 4.2.4 Third rinse in potable water.
 - 4.2.5 Component is removed from rack.
 - 4.2.6 Final rinse in D.I. Water.
 - 4.2.7 Place component in Class 100 clean station for cool down and drying.

5.0 PACKAGING

5.1 Standard Packaging

- 5.1.1 Component is placed in a poly bag and heat sealed to protect it from handling contamination.
- 5.1.2 Component is placed in a suitable shipping container, cushioned by packing material and sealed for shipping.

5.2 CLASS 100 PACKAGING

- 5.2.1 Component is retained under a Class 100 clean station laminar flow hood.

- 5.2.2 Component is rinsed in a cold D.I. Water bath.
- 5.2.3 Component is rinsed in a second bath of hot (150 dg. F) D.I. Water rinse.
- 5.2.4 Component is blown dry with Nitrogen Gas, filtered to .02 micron at room temperature.
- 5.2.5 If excess D.I. Water is present, a lint free wipe shall be used to absorb moisture.
- 5.2.6 The component is placed in a 2 mil poly bag, purged with Nitrogen Gas and heat sealed.
- 5.2.7 The bagged component is placed in an outer 6 mil poly bag and heat sealed.
- 5.2.8 A label is attached to the bag denoting the part number and Class 100 package information.
- 5.2.9 Component is placed in a suitable shipping container, cushioned by packing material and sealed for shipping.

6.0 SHIPPING

- 6.1 All orders are shipped by the most effective means and/or customer instructions.